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N-Channel Shielded Gate PowerTrench[®] MOSFET



Power 56

Symbol	Parameter			Ratings	Units
V _{DS}	Drain to Source Voltage			80	V
V _{GS}	Gate to Source Voltage			±20	V
	Drain Current -Continuous	T _C = 25 °C		60	
I _D	-Continuous	T _A = 25 °C	(Note 1a)	13	Α
	-Pulsed			200	
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	135	mJ
D	Power Dissipation	on $T_{\rm C} = 25 ^{\circ}{\rm C}$		104	w
P _D	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5	vv
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C
Thermal Ch	naracteristics				
R _{θJC}	Thermal Resistance, Junction to Case			1.2	

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$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case	1.2	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Note 1a)	50	C/ VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86322	FDMS86322	Power 56	13 "	12 mm	3000 units

FAIRCHILD

FDMS86322



October 2014

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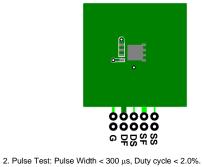
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Symbol	Parameter Test Conditions		Min	Тур	Max	Units	
Off Chara	acteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	80			V	
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		66		mV/°C	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 64 V, V _{GS} = 0 V			800	nA	
I _{GSS}	Gate to Source Leakage Current, Forward	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA	
On Chara	acteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	2.0	2.9	4.0	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		-9		mV/°C	
		V _{GS} = 10 V, I _D = 13 A		6.1	7.65		
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 6 V, I _D = 7.2 A		8.2	12	mΩ	
(<i>'</i>		V _{GS} = 10 V, I _D = 13 A, T _J = 125 °C		10.7	14		
		$V_{GS} = 10 V, 10 = 10 A, 11 = 120 O$		10.1			
9fs	Forward Transconductance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 13 \text{ A}$		45		S	
Dynamic	Characteristics			45		1	
Dynamic C _{iss}	Characteristics	V _{DS} = 10 V, I _D = 13 A		45 2255	3000	pF	
Dynamic C _{iss} C _{oss}	Characteristics Input Capacitance Output Capacitance			45 2255 460	3000 610	pF pF	
Dynamic C _{iss} C _{oss} C _{rss}	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 13 \text{ A}$ - $V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		45 2255 460 30	3000	pF pF pF	
Dynamic C _{iss} C _{oss}	Characteristics Input Capacitance Output Capacitance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 13 \text{ A}$ - $V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		45 2255 460	3000 610	pF pF	
Dynamic C _{iss} C _{oss} C _{rss} R _g	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 13 \text{ A}$ - $V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		45 2255 460 30	3000 610	pF pF pF	
Dynamic C _{iss} C _{oss} C _{rss} R _g Switching	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 13 \text{ A}$ - $V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		45 2255 460 30	3000 610	pF pF pF	
Dynamic C _{iss} C _{oss} C _{rss} R _g Switching	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 13 \text{ A}$ - $V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ - f = 1 MHz - $V_{DD} = 50 \text{ V}, \text{ I}_{D} = 13 \text{ A},$		45 2255 460 30 1.0	3000 610 45	pF pF pF Ω	
Dynamic C _{iss} C _{oss} C _{rss} R _g Switching	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 13 \text{ A}$ $V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1 MHz		45 2255 460 30 1.0 15	3000 610 45 27	pF pF pF Ω ns	
Dynamic C_{iss} C_{oss} C_{rss} R_g Switching $t_{d(on)}$ t_r	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 13 \text{ A}$ - $V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ - f = 1 MHz - $V_{DD} = 50 \text{ V}, \text{ I}_{D} = 13 \text{ A},$		45 2255 460 30 1.0 15 11	3000 610 45 27 20	pF pF pF Ω ns	
Dynamic C_{iss} C_{oss} C_{rss} R_g Switching $t_{d(on)}$ t_r $t_{d(off)}$	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 13 \text{ A}$ $V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ $f = 1 \text{ MHz}$ $V_{DD} = 50 \text{ V}, \text{ I}_{D} = 13 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$		45 2255 460 30 1.0 15 11 27	3000 610 45 27 20 44	pF pF Ω ns ns	
Dynamic C_{iss} C_{oss} C_{rss} R_g Switching $t_{d(on)}$ t_r $t_{d(off)}$ t_f	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 13 \text{ A}$ $V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ $f = 1 \text{ MHz}$ $V_{DD} = 50 \text{ V}, \text{ I}_{D} = 13 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 5 \text{ V},$ $V_{DD} = 50 \text{ V},$		45 2255 460 30 1.0 15 11 27 7	3000 610 45 27 20 44 13	pF pF Ω ns ns ns ns	
Dynamic C_{iss} C_{css} C_{rss} R_g Switching $t_{d(on)}$ t_r $t_{d(off)}$ t_f Q_g	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 13 \text{ A}$ $V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ $f = 1 \text{ MHz}$ $V_{DD} = 50 \text{ V}, \text{ I}_{D} = 13 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		45 2255 460 30 1.0 15 11 27 7 39	3000 610 45 27 20 44 13 55	pF pF Ω ns ns ns ns nc	

V.	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2.1 A$ (Note 2)	0.7	1.2	V	
V _{SD}	Source to Drain Didde Porward Voltage	$V_{GS} = 0 V, I_S = 13 A$ (Note 2)	0.8	1.3	v	
t _{rr}	Reverse Recovery Time	I _E = 13 A, di/dt = 100 A/μs	56	90	ns	
Q _{rr}	Reverse Recovery Charge	$F = 15 \text{ A}, \text{ u/ut} = 100 \text{ A/} \mu \text{s}$	61	98	nC	

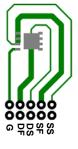
Notes:

1. R_{0JA} is determined with the device mounted on a 1in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.

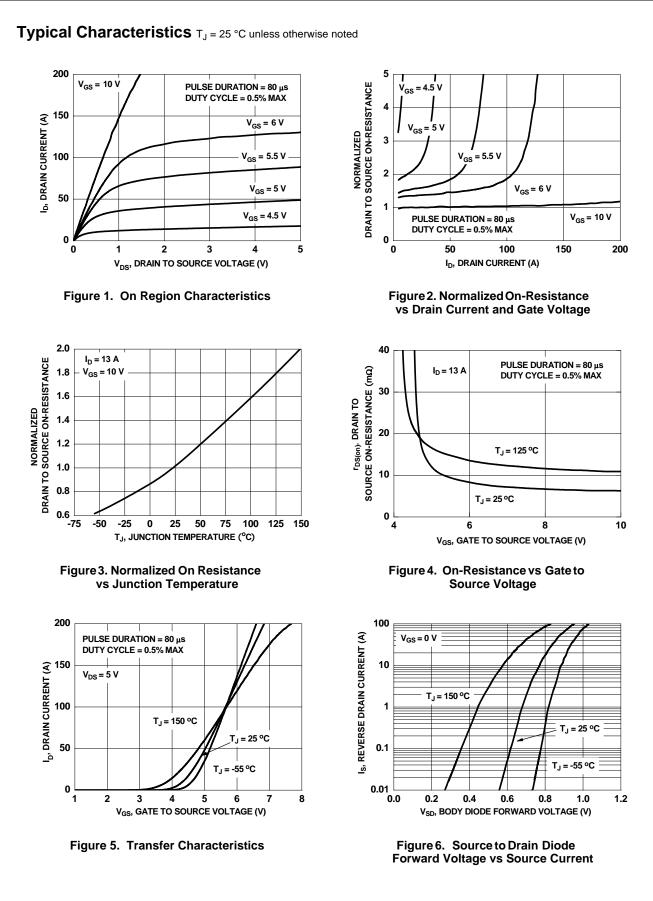


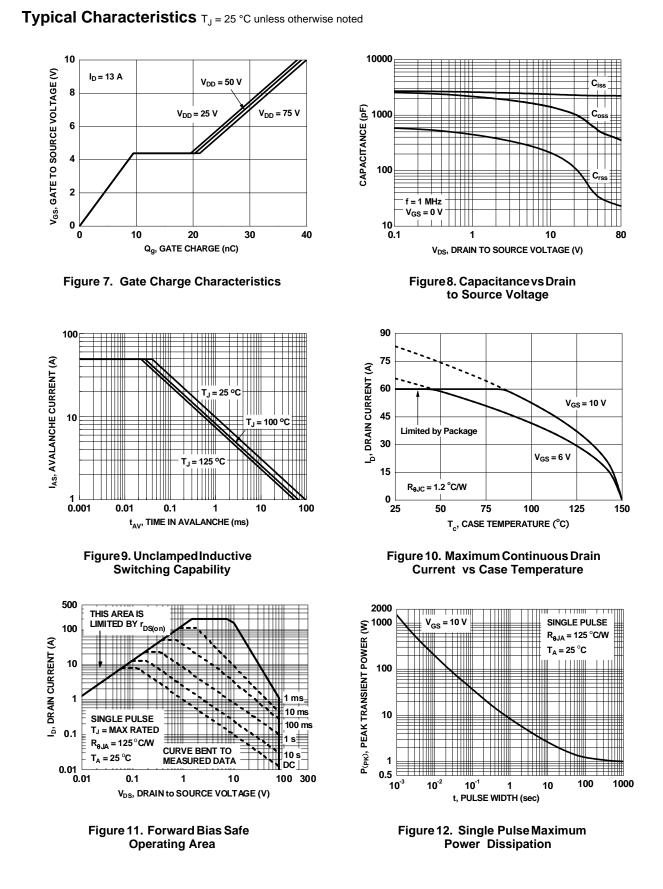
3. Starting T_J = 25 °C, L = 0.3 mH, I_{AS} = 30 A, V_{DD} = 75 V, V_{GS} = 10 V

a. 50 °C/W when mounted on a 1 in² pad of 2 oz copper.

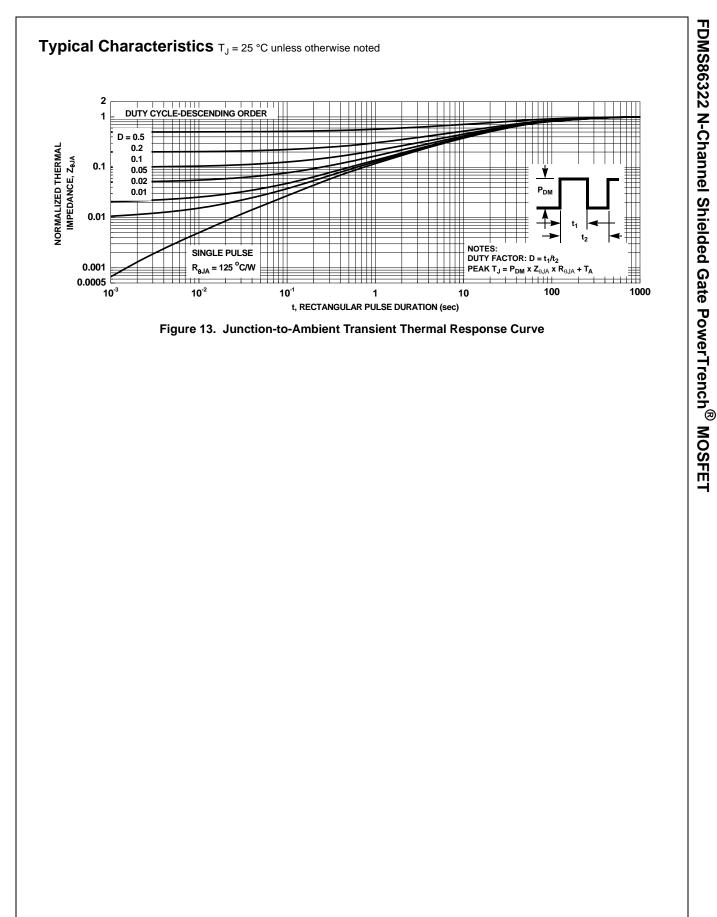


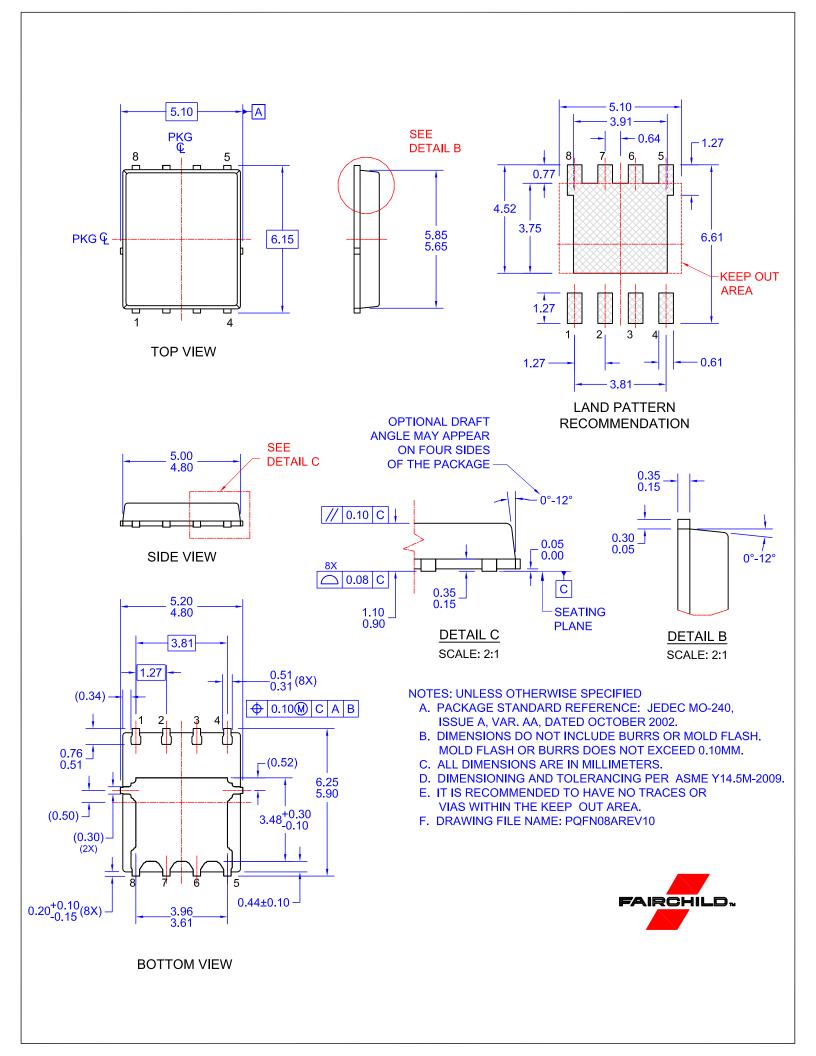
b. 125 °C/W when mounted on a minimum pad of 2 oz copper.





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